## LMH6570

## 2:1 High Speed Video Multiplexer

## General Description

The $\mathrm{LMH}^{\text {TM }} 6570$ is a high performance analog multiplexer optimized for professional grade video and other high fidelity high bandwidth analog applications. The output amplifier selects one of two buffered input signals based on the state of the SEL pin. The LMH6570 provides a 400 MHz bandwidth at $2 \mathrm{~V}_{\mathrm{PP}}$ output signal levels. Multimedia and high definition television (HDTV) applications can benefit from the LMH6570's 0.1 dB bandwidth of 150 MHz and its $2200 \mathrm{~V} / \mathrm{hs}$ slew rate.
The LMH6570 supports composite video applications with its $0.02 \%$ and $0.05^{\circ}$ differential gain and phase errors for NTSC and PAL video signals while driving a single, back terminated $75 \Omega$ load. An 80 mA linear output current is available for driving multiple video load applications.
The LMH6570 gain is set by external feedback and gain set resistors for maximum flexibility.
The LMH6570 is available in the 8 pin SOIC package.

Features

- $500 \mathrm{MHz}, 500 \mathrm{mV}$ PP, -3 dB bandwidth, $\mathrm{A}_{\mathrm{V}}=2$
- $400 \mathrm{MHz}, 2 \mathrm{~V}_{\mathrm{PP}},-3 \mathrm{~dB}$ bandwidth, $\mathrm{A}_{\mathrm{V}}=2$
- 8 ns channel switching time

■ 70 dB channel to channel isolation @ 10 MHz

- $0.02 \%, 0.05^{\circ}$ diff. gain, diff. phase
- 0.1 dB gain flatness to 150 MHz
- $2200 \mathrm{~V} / \mu \mathrm{s}$ slew rate
- Wide supply voltage range: $6 \mathrm{~V}( \pm 3 \mathrm{~V})$ to $12 \mathrm{~V}( \pm 6 \mathrm{~V})$
- -68 dB HD2 @ 5 MHz
- -84 dB HD3 @ 5 MHz


## Applications

- Video router
- Multi input video monitor
- Instrumentation / Test equipment
- Receiver IF diversity switch
- Multi channel A/D driver
- Picture in Picture video switch


## Connection Diagram



## Truth Table

| SEL | SD | OUTPUT |
| :---: | :---: | :---: |
| 1 | 0 | IN1 * $1+\mathrm{RF} / \mathrm{RG})$ |
| 0 | 0 | INO * $1+\mathrm{RF} / \mathrm{RG})$ |
| X | 1 | Shutdown |

Absolute Maximum Ratings (Note 1)
If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| ESD Tolerance | (Note 4) |
| :--- | ---: |
| Human Body Model | 2000 V |
| Machine Model | 200 V |
| Supply Voltage $\left(\mathrm{V}^{+}-\mathrm{V}^{-}\right)$ | 13.2 V |
| Iout (Note 3) | 130 mA |
| Signal \& Logic Input Pin Voltage | $\pm\left(\mathrm{V}_{\mathrm{S}}+0.6 \mathrm{~V}\right)$ |
| Signal \& Logic Input Pin Current | $\pm 20 \mathrm{~mA}$ |
| Maximum Junction Temperature | $+150^{\circ} \mathrm{C}$ |


| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Soldering Information |  |
| Infrared or Convection $(20 \mathrm{sec})$ | $235^{\circ} \mathrm{C}$ |
| Wave Soldering $(10 \mathrm{sec})$ | $260^{\circ} \mathrm{C}$ |

## Operating Ratings (Note 1)

| Operating Temperature | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| :--- | :--- |
| Supply Voltage Range | 6 V to 12 V |

upply Voltage Range
Thermal Resistance
Package
8-Pin SOIC

| $\left(\theta_{\mathrm{JA}}\right)$ | $\left(\theta_{\mathrm{JC}}\right)$ |
| :--- | ---: |
| $150^{\circ} \mathrm{C} / \mathrm{W}$ | $50^{\circ} \mathrm{C} / \mathrm{W}$ |

## $\pm 5 \mathrm{~V}$ Electrical Characteristics

$V_{S}= \pm 5 \mathrm{~V}, R_{L}=100 \Omega, R_{F}=576 \Omega, A_{V}=2 \mathrm{~V} / \mathrm{V}, \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$. Unless otherwise specified. Bold numbers specify limits at temperature extremes.

| Symbol | Parameter | Conditions (Note 2) | $\begin{array}{\|c\|} \hline \text { Min } \\ (\text { Note 5) } \end{array}$ | Typ (Note 9) | $\begin{array}{c\|} \hline \text { Max } \\ \text { (Note 5) } \end{array}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Performance |  |  |  |  |  |  |
| SSBW | -3 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {PP }}$ |  | 500 |  | MHz |
| LSBW | -3 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=2 \mathrm{~V}_{\text {PP }}$ |  | 400 |  | MHz |
| . 1 dBBW | 0.1 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=0.25 \mathrm{~V}_{\text {PP }}$ |  | 150 |  | MHz |
| DG | Differential Gain | $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{f}=4.43 \mathrm{MHz}$ |  | 0.02 |  | \% |
| DP | Differential Phase | $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{f}=4.43 \mathrm{MHz}$ |  | 0.05 |  | deg |
| XTLK | Channel to Channel Crosstalk | All Hostile, $\mathrm{f}=5 \mathrm{MHz}$ |  | -70 |  | dBc |
| Time Domain Response |  |  |  |  |  |  |
| TRS | Channel to Channel Switching Time | Logic transition to 90\% output |  | 8 |  | ns |
|  | Enable and Disable Times | Logic transition to $90 \%$ or $10 \%$ output. |  | 10 |  | ns |
| TRL | Rise and Fall Time | 4V Step |  | 2.4 |  | ns |
| TSS | Settling Time to 0.05\% | 2V Step |  | 17 |  | ns |
| OS | Overshoot | 2V Step |  | 5 |  | \% |
| SR | Slew Rate | 4V Step, (Note 8) |  | 2200 |  | V/us |
| Distortion |  |  |  |  |  |  |
| HD2 | $2^{\text {nd }}$ Harmonic Distortion | $2 \mathrm{~V}_{\mathrm{PP}}, 5 \mathrm{MHz}$ |  | -68 |  | dBc |
| HD3 | $3{ }^{\text {rd }}$ Harmonic Distortion | $2 \mathrm{~V}_{\mathrm{PP}}, 5 \mathrm{MHz}$ |  | -84 |  | dBc |
| IMD | $33^{\text {rd }}$ Order Intermodulation Products | 10 MHz , Two tones 2 Vpp at output |  | -80 |  | dBc |
| Equivalent Input Noise |  |  |  |  |  |  |
| VN | Voltage | >1 MHz, Input Referred |  | 5 |  | $\mathrm{nV} \sqrt{\mathrm{Hz}}$ |
| ICN | Current | >1 MHz, Input Referred |  | 5 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |

Static, DC Performance

| $\pm$ CHGM | Channel to Channel Gain Difference | DC, Difference in gain between <br> channels |  | $\pm 0.005$ <br> $\pm 0.034$ <br> $\pm 0.036$ | $\%$ |  |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| VIO | Input Offset Voltage | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | 1 | $\pm 15$ <br> $\pm 21$ | mV |
| DVIO | Offset Voltage Drift (Note 10) |  |  | 30 |  | $\mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$ |
| IBN | Input Bias Current (Note 7) | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | -3 | $\pm 5.5$ <br> $\pm 6.2$ | $\mu \mathrm{~A}$ |
| IBN | Bias Current Drift (Note 10) |  |  | 11 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| IBI | Inverting Input Bias Current (Note 7) | Pin 8, Feedback point, <br> $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ | -3 | $\pm 18$ <br> $\pm 22$ | uA |  |
| PSRR | Power Supply Rejection Ratio | DC, Input referred | 48 <br> 46 | 50 |  | dB |

$V_{S}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{R}_{\mathrm{F}}=576 \Omega, \mathrm{~A}_{\mathrm{V}}=2 \mathrm{~V} / \mathrm{V}, \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$. Unless otherwise specified. Bold numbers specify limits at temperature extremes.

| Symbol | Parameter | Conditions (Note 2) |  | $\begin{array}{\|c\|} \hline \text { Typ } \\ \text { (Note 9) } \\ \hline \end{array}$ | $\begin{gathered} \text { Max } \\ (\text { Note 5) } \end{gathered}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ICC | Supply Current | $\begin{aligned} & \text { No Load, Shutdown Pin (SD) > } \\ & 0.8 \mathrm{~V} \end{aligned}$ |  | 13.8 | $\begin{aligned} & 15 \\ & 16 \end{aligned}$ | mA |
|  | Supply Current Shutdown | Shutdown Pin (SD) > 2V |  | 1.1 | $\begin{aligned} & 1.3 \\ & 1.4 \end{aligned}$ | mA |
| VIH | Logic High Threshold | Select Pin \& Shutdown pin (SEL, SD) | 2.0 |  |  | V |
| VIL | Logic Low Threshold | Select Pin \& Shutdown pin (SEL, SD) |  |  | 0.8 | V |
| IiL | Logic Pin Input Current Low (Note 7) | Logic Input = OV Select Pin \& Shutdown pin (SEL, SD) | $\begin{gathered} \hline-2.9 \\ -10 \\ \hline \end{gathered}$ | -1 |  | $\mu \mathrm{A}$ |
| $\stackrel{\mathrm{liH}}{ }$ | Logic Pin Input Current High (Note 7) | Logic Input $=5.0 \mathrm{~V}$, Select Pin \& Shutdown pin (SEL, SD) |  | 57 | $\begin{aligned} & 68 \\ & 75 \end{aligned}$ | $\mu \mathrm{A}$ |
| Miscellaneous Performance |  |  |  |  |  |  |
| RIN+ | Input Resistance |  |  | 5 |  | $\mathrm{k} \Omega$ |
| CIN | Input Capacitance |  |  | 0.8 |  | pF |
| ROUT | Output Resistance | Output Active, (SD < 0.8V) |  | 0.04 |  | $\Omega$ |
| ROUT | Output Resistance | Output Disabled, (SD > 2V) |  | 3000 |  | $\Omega$ |
| COUT | Output Capacitance | Output Disabled, (SD > 2V) |  | 3.1 |  | pF |
| VO | Output Voltage Range | No Load | $\begin{aligned} & \pm 3.51 \\ & \pm 3.50 \end{aligned}$ | $\pm 3.7$ |  | V |
| VOL |  | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ | $\begin{aligned} & \pm 3.16 \\ & \pm 3.15 \end{aligned}$ | $\pm 3.5$ |  | V |
| CMIR | Input Voltage Range |  | $\pm 2.5$ | $\pm 2.6$ |  | V |
| 10 | Linear Output Current (Note 7) | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$, | $\begin{aligned} & +60 \\ & -70 \\ & \pm 55 \\ & \hline \end{aligned}$ | $\pm 80$ |  | mA |
| ISC | Short Circuit Current(Note 3) | $\mathrm{V}_{\mathrm{IN}}= \pm 2 \mathrm{~V}$, Output shorted to ground |  | $\pm 230$ |  | mA |

## $\pm 3.3 \mathrm{~V}$ Electrical Characteristics

$\mathrm{V}_{\mathrm{S}}= \pm 3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{R}_{\mathrm{F}}=576 \Omega, \mathrm{~A}_{\mathrm{V}}=2 \mathrm{~V} / \mathrm{V}$; Unless otherwise specified.

| Symbol | Parameter | Conditions (Note 2) | Min <br> $($ Note 5 $)$ | Typ <br> $($ Note 9) | Max <br> $($ Note 5) | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

## Frequency Domain Performance

| SSBW | -3 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {PP }}$ |  | 475 | MHz |  |
| :--- | :--- | :--- | :--- | :---: | :---: | :---: |
| LSBW | -3 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=2.0 \mathrm{~V}_{\text {PP }}$ |  | 375 | MHz |  |
| 0.1 dBBW | 0.1 dB Bandwidth | $\mathrm{V}_{\text {OUT }}=0.5 \mathrm{~V}_{\text {PP }}$ |  | 100 |  | MHz |
| GFP | Peaking | DC to 200 MHz |  | 0.4 | dB |  |
| XTLK | Channel to Channel Crosstalk | All Hostile, $\mathrm{f}=5 \mathrm{MHz}$ | -70 | dBc |  |  |

Time Domain Response

| TRL | Rise and Fall Time | 2V Step | 2 | ns |
| :---: | :---: | :---: | :---: | :---: |
| TSS | Settling Time to 0.05\% | 2V Step | 20 | ns |
| OS | Overshoot | 2V Step | 5 | \% |
| SR | Slew Rate | 2V Step | 1400 | V/us |
| Distortion |  |  |  |  |
| HD2 | $2^{\text {nd }}$ Harmonic Distortion | $2 \mathrm{~V}_{\mathrm{PP}}, 10 \mathrm{MHz}$ | -67 | dBc |
| HD3 | $33^{\text {rd }}$ Harmonic Distortion | $2 \mathrm{~V}_{\mathrm{PP}}, 10 \mathrm{MHz}$ | -87 | dBc |

Static, DC Performance

## $\pm 3.3 \mathrm{~V}$ Electrical Characteristics

(Continued)

| Symbol | Parameter | Conditions (Note 2) | $\begin{gathered} \operatorname{Min} \\ (\text { Note 5) } \end{gathered}$ | $\begin{gathered} \text { Typ } \\ \text { (Note 9) } \end{gathered}$ | $\begin{gathered} \text { Max } \\ (\text { Note 5) } \end{gathered}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VIO | Input Offset Voltage | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | 1 |  | mV |
| IBN | Input Bias Current (Note 7) | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | -3 |  | $\mu \mathrm{A}$ |
| PSRR | Power Supply Rejection Ratio | DC, Input Referred |  | 49 |  | dB |
| ICC | Supply Current | No Load |  | 12.5 |  | mA |
| VIH | Logic High Threshold | Select Pin \& Shutdown pin (SEL, SD), $\mathrm{VIH} \cong \mathrm{~V}^{+*} 0.4$ |  | 1.3 |  | V |
| VIL | Logic Low Threshold | Select Pin \& Shutdown pin (SEL, SD), $\mathrm{VIL} \cong \mathrm{~V}^{+} \text {* } 0.12$ |  | 0.4 |  | V |
| Miscellaneous Performance |  |  |  |  |  |  |
| RIN+ | Input Resistance |  |  | 5 |  | $\mathrm{k} \Omega$ |
| CIN | Input Capacitance |  |  | 0.8 |  | pF |
| ROUT | Output Resistance |  |  | 0.06 |  | $\Omega$ |
| VO | Output Voltage Range | No Load |  | $\pm 2$ |  | V |
| VOL |  | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ |  | $\pm 1.8$ |  | V |
| CMIR | Input Voltage Range |  |  | $\pm 1.2$ |  | V |
| 10 | Linear Output Current (Note 3) | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |  | $\pm 60$ |  | mA |
| ISC | Short Circuit Current (Note 3) | $\mathrm{V}_{\mathrm{IN}}= \pm 1 \mathrm{~V}$, Output shorted to ground |  | $\pm 150$ |  | mA |

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications, see the Electrical Characteristics tables.

Note 2: Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_{J}=T_{A}$. No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self heating where $T_{J}>T_{A}$. See Applications Section for information on temperature de-rating of this device. Min/Max ratings are based on product testing, characterization and simulation. Individual parameters are tested as noted.
Note 3: The maximum output current (lout) is determined by the device power dissipation limitations (The junction temperature cannot be allowed to exceed $150^{\circ} \mathrm{C}$ ). See the Power Dissipation section of the Application Section for more details. A short circuit condition should be limited to 5 seconds or less
Note 4: Human Body model, $1.5 \mathrm{k} \Omega$ in series with 100 pF . Machine model, $0 \Omega$ In series with 200 pF
Note 5: Limits are $100 \%$ production tested at $25^{\circ} \mathrm{C}$. Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control SQC) methods.
Note 6: Parameter guaranteed by design.
Note 7: Positive Value is current into device.
Note 8: Slew Rate is the average of the rising and falling edges.
Note 9: Typical numbers are the most likely parametric norm
Note 10: Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.

## Ordering Information

| Package | Part Number | Package Marking | Transport Media | NSC Drawing |
| :---: | :---: | :---: | :---: | :---: |
| 8-Pin SOIC | LMH6570MA | LMH6570MA | 95 Units/Rail | M08A |
|  | LMH6570MAX |  | 2.5 k Units Tape and Reel |  |

Typical Performance Characteristics $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~A}_{\mathrm{V}}=2, \mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{G}}=576 \Omega$; unless otherwise specified.


20129902
Frequency Response vs. Capacitive Load


20129914
Suggested Value of $R_{F}$ vs. Gain


Frequency Response vs. Gain


20129903
Suggested R $_{\text {Out }}$ vs. Capacitive Load


Pulse Response $4 V_{\text {PP }}$


20129925

Typical Performance Characteristics $\mathrm{V}_{\mathrm{s}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~A}_{\mathrm{V}}=2, \mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{G}}=576 \Omega$; unless otherwise specified. (Continued)


20129929
Closed Loop Output Impedance


20129908
PSRR vs. Frequency


Pulse Response 2V $\mathbf{V P}$


20129930
Closed Loop Output Impedance


Channel Switching


Typical Performance Characteristics $\mathrm{v}_{\mathrm{s}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~A}_{\mathrm{V}}=2, \mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{G}}=576 \Omega$; unless otherwise specified. (Continued)


20129921


HD2 vs. $V_{\text {s }}$


20129907

## Shutdown Glitch



20129927


HD3 vs. Vs


Typical Performance Characteristics $\mathrm{v}_{\mathrm{s}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=100 \Omega, \mathrm{~A}_{\mathrm{V}}=2, \mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{G}}=576 \Omega$; unless otherwise specified. (Continued)


Minimum V $_{\text {OUT }}$ vs. $I_{\text {OuT }}$ (Note 7)


Crosstalk vs. Frequency


HD3 vs. V


20129906
Maximum $\mathrm{V}_{\text {Out }}$ vs. $\mathrm{I}_{\text {Out }}$ (Note 7)


20129913
Off Isolation


## Application Notes

## GENERAL INFORMATION



FIGURE 1. Typical Application

The LMH6570 is a high-speed 2:1 analog multiplexer, optimized for very high speed and low distortion. With selectable gain and excellent AC performance, the LMH6570 is ideally suited for switching high resolution, presentation grade video signals. The LMH6570 has no internal ground reference. Single or split supply configurations are both possible, however, all logic functions are referenced to the mid supply point. The LMH6570 features very high speed channel switching and disable times. When disabled the LMH6570 output is high impedance making MUX expansion possible by combining multiple devices. See "Multiplexer Expansion" section below. The LMH6570 SEL defaults to logic low (INO active). The default state for the SD pin is also logic low (device enabled). Both pins can be left floating if the default state is desired.

## VIDEO PERFORMANCE

The LMH6570 has been designed to provide excellent performance with production quality video signals in a wide variety of formats such as HDTV and High Resolution VGA. Best performance will be obtained with back-terminated loads. The back termination reduces reflections from the transmission line and effectively masks transmission line and other parasitic capacitances from the amplifier output stage. Figure 1 shows a typical configuration for driving a $75 \Omega$ cable. The output buffer is configured for a gain of 2 , so using back terminated loads will give a net gain of 1 .

FEEDBACK RESISTOR SELECTION


20129932
FIGURE 2. Suggested $R_{F}$ vs. Gain
The LMH6570 has a current feedback output buffer with gain determined by external feedback $\left(\mathrm{R}_{\mathrm{F}}\right)$ and gain set $\left(\mathrm{R}_{\mathrm{G}}\right)$ resistors. With current feedback amplifiers, the closed loop frequency response is a function of $R_{F}$. For a gain of $2 \mathrm{~V} / \mathrm{V}$, the recommended value of $R_{F}$ is $576 \Omega$. For other gains see the chart "Suggested $R_{F}$ vs Gain". Generally, lowering $R_{F}$ from the recommended value will peak the frequency re-

## Application Notes (Continued)

sponse and extend the bandwidth while increasing the value of $R_{F}$ will cause the frequency response to roll off faster. Reducing the value of $R_{F}$ too far below the recommended value will cause overshoot, ringing and, eventually, oscillation.

Since all applications are slightly different it is worth some experimentation to find the optimal $R_{F}$ for a given circuit. For more information see Application Note OA-13 which describes the relationship between $\mathrm{R}_{\mathrm{F}}$ and closed-loop frequency response for current feedback operational amplifiers. The impedance looking into pin 8 is approximately $20 \Omega$. This allows for good bandwidth at gains up to $10 \mathrm{~V} / \mathrm{V}$. When used with gains over $10 \mathrm{~V} / \mathrm{V}$, the LMH6570 will exhibit a "gain bandwidth product" similar to a typical voltage feedback amplifier. For gains of over $10 \mathrm{~V} / \mathrm{V}$ consider selecting a high performance video amplifier like the LMH6720 to provide additional gain.

## EVALUATION BOARDS

National Semiconductor provides the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization. Many of the data sheet plots were measured with this board.

| Device | Package | Evaluation Board |
| :--- | :--- | :--- |
| LMH6570 | SOIC | LMH730277 |

An evaluation board can be shipped when a sample request is placed with National Semiconductor. Samples can be ordered on the National web page. (www.national.com)

## MULTIPLEXER EXPANSION

With the SHUTDOWN pin putting the output stage into a high impedance state, several LMH6570's can be tied together to form a larger input MUX. However, there is a
loading effect on the active output caused by the unselected devices. The circuit in Figure 3 shows how to compensate for this effect. For the 8:1 MUX function shown in Figure 3 below the gain error would be about $0.7 \%$ or -0.06 dB . In the circuit in Figure 3, resistor ratios have been adjusted to compensate for this gain error. By adjusting the gain of each multiplexer circuit the error can be reduced to the tolerance of the resistors used ( $1 \%$ in this example).


20129917

FIGURE 3. Multiplexer Gain Compensation

BUILDING A 4:1 MULITPLEXER
Figure 4 shows an 4:1 MUX using two LMH6570's.

## Application Notes



FIGURE 4. 4:1 MUX USING TWO LMH6570's


FIGURE 5. Delay Circuit Implementation
If it is important in the end application to make sure that no two inputs are presented to the output at the same time, an optional delay block can be added, to drive the SHUTDOWN pin of each device, as shown. Figure 5 shows one possible approach to this delay circuit. The delay circuit shown will delay SHUTDOWN's $H$ to $L$ transitions ( $\mathrm{R}_{1}$ and $\mathrm{C}_{1}$ decay)
but won't delay its L to H transition. $\mathrm{R}_{2}$ should be kept small compared to $\mathrm{R}_{1}$ in order to not reduce the SHUTDOWN voltage and to produce little or no delay to SHUTDOWN.

## Other Applications

The LMH6570 could support a dual antenna receiver with two physically separate antennas. Monitoring the signal strength of the active antenna and switching to the other antenna when a fade is detected is a simple way to achieve spacial diversity. This method gives about a 3dB boost in average signal strength and is the least expensive method for combining signals.

## DRIVING CAPACITIVE LOADS

Capacitive output loading applications will benefit from the use of a series output resistor $\mathrm{R}_{\text {Out }}$. Figure 6 shows the use of a series output resistor, $\mathrm{R}_{\text {OUt }}$, to stabilize the amplifier output under capacitive loading. Capacitive loads of

## Other Applications (Continued)

5 to 120 pF are the most critical, causing ringing, frequency response peaking and possible oscillation. The chart "Suggested $\mathrm{R}_{\text {out }}$ vs. Cap Load" gives a recommended value for selecting a series output resistor for mitigating capacitive loads. The values suggested in the charts are selected for 0.5 dB or less of peaking in the frequency response. This gives a good compromise between settling time and bandwidth. For applications where maximum frequency response is needed and some peaking is tolerable, the value of $R_{\text {OUT }}$ can be reduced slightly from the recommended values.


FIGURE 6. Decoupling Capacitive Loads


20129915
FIGURE 7. Suggested R $_{\text {Out }}$ vs. Capacitive Load


FIGURE 8. Frequency Response vs. Capacitive Load

## LAYOUT CONSIDERATIONS

Whenever questions about layout arise, use the evaluation board as a guide. The LMH730277 is the evaluation board supplied with samples of the LMH6570. To reduce parasitic capacitances, ground and power planes should be removed near the input and output pins. For long signal paths controlled impedance lines should be used, along with impedance matching elements at both ends. Bypass capacitors should be placed as close to the device as possible. Bypass capacitors from each rail to ground are applied in pairs. The larger electrolytic bypass capacitors can be located farther from the device, the smaller ceramic capacitors should be placed as close to the device as possible. In Figure 1, the capacitor between $\mathrm{V}^{+}$and $\mathrm{V}^{-}$is optional, but is recommended for best second harmonic distortion. Another way to enhance performance is to use pairs of $0.01 \mu \mathrm{~F}$ and $0.1 \mu \mathrm{~F}$ ceramic capacitors for each supply bypass.

## POWER DISSIPATION

The LMH6570 is optimized for maximum speed and performance in the small form factor of the standard SOIC package. To ensure maximum output drive and highest performance, thermal shutdown is not provided. Therefore, it is of utmost importance to make sure that the $T_{\text {JMAX }}$ is never exceeded due to the overall power dissipation.
Follow these steps to determine the maximum power dissipation for the LMH6570:

1. Calculate the quiescent (no-load) power: $\mathrm{P}_{\mathrm{AMP}}=\mathrm{I}_{\mathrm{CC}}{ }^{*}$ $\left(\mathrm{V}_{\mathrm{S}}\right)$, where $\mathrm{V}_{\mathrm{S}}=\mathrm{V}^{+}-\mathrm{V}^{-}$.
2. Calculate the RMS power dissipated in the output stage: $P_{D}(\mathrm{rms})=\mathrm{rms}\left(\left(\mathrm{V}_{\mathrm{S}}-\mathrm{V}_{\text {OUT }}\right)\right.$ * $\left.\mathrm{I}_{\text {OUT }}\right)$, where $\mathrm{V}_{\text {OUT }}$ and $\mathrm{l}_{\text {out }}$ are the voltage across and the current through the external load and $\mathrm{V}_{\mathrm{S}}$ is the total supply voltage.
3. Calculate the total RMS power: $P_{T}=P_{A M P}+P_{D}$.

The maximum power that $t$-he LMH6570 package can dissipate at a given temperature can be derived with the following equation:
$\mathrm{P}_{\mathrm{MAX}}=\left(150^{\circ}-\mathrm{T}_{\mathrm{AMB}}\right) / \theta_{\mathrm{JA}}$, where $\mathrm{T}_{\mathrm{AMB}}=$ Ambient temperature $\left({ }^{\circ} \mathrm{C}\right)$ and $\theta_{\mathrm{JA}}=$ Thermal resistance, from junction to ambient, for a given package ( ${ }^{\circ} \mathrm{C} / \mathrm{W}$ ). For the SOIC package $\theta_{\mathrm{JA}}$ is $150{ }^{\circ} \mathrm{C} / \mathrm{W}$.

## Other Applications

(Continued)

## ESD PROTECTION

The LMH6570 is protected against electrostatic discharge (ESD) on all pins. The LMH6570 will survive 2000V Human Body model and 200V Machine model events. Under normal operation the ESD diodes have no effect on circuit performance. There are occasions, however, when the ESD di-
odes will be evident. If the LMH6570 is driven by a large signal while the device is powered down the ESD diodes will conduct. The current that flows through the ESD diodes will either exit the chip through the supply pins or will flow through the device, hence it is possible to power up a chip with a large signal applied to the input pins. Using the shutdown mode is one way to conserve power and still prevent unexpected operation.

Physical Dimensions inches (millimeters) unless otherwise noted


National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.
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## LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## BANNED SUBSTANCE COMPLIANCE

National Semiconductor manufactures products and uses packing materials that meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.

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